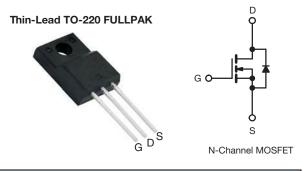
SiHA25N50E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.145				
Q _g max. (nC)	86				
Q _{gs} (nC)	14				
Q _{gd} (nC)	25				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATONS

- · Hard switched topologies
- Power factor correction power supplies (PFC)
- Switch mode power supplies (SMPS)
- Computing
 - PC silver box / ATX power supplies
- Lighting
- Two stage LED lighting

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA25N50E-E3			
Lead (Pb)-free and halogen-free	SiHA25N50E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	500	V	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain current (T _J = 150 °C) $^{\circ}$	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	۱ _D	26		
	VGS AL TO V	T _C = 100 °C		16	А	
Pulsed drain current ^a			I _{DM}	50		
Linear derating factor				0.2	W/°C	
Single pulse avalanche energy ^b			E _{AS}	273	mJ	
Maximum power dissipation			PD	35	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$V_{DS} = 0 V t$	o 80 % V _{DS}	-1) / / -14	65	\//==	
Reverse diode dV/dt ^d			dV/dt	25	V/ns	
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C	
Mounting torque M3 screw				0.6	Nm	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.4 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

e. Limited by maximum junction temperature

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	3.6	0/10	

S17-1308-Rev. E, 21-Aug-17

For technical questions, contact: hvm@vishay.com

Document Number: 91628



COMPLIANT HALOGEN

FREE Available

1

SiHA25N50E



Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•	•	•	•
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μΑ	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.59	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
	_	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA
Zaus asta valta sa shusia sumant		V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 400 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	25	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 12 A	-	0.125	0.145	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 12 A	-	6.6	-	S
Dynamic		•					
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	1980	-	-
Output capacitance	C _{oss}		V _{DS} = 100 V,	-	105	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	8	-	
Effective output capacitance, energy related ^a	C _{o(er)}			-	105	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{\rm DS} = 0.0$	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		285	-	
Total gate charge	Qg				57	86	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 12 \text{ A}, V_{DS} = 400 \text{ V}$		-	14	-	
Gate-drain charge	Q _{gd}				25	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 400 V, I _D = 12 A		-	19	38	
Rise time	t _r			-	36	72	Π.
Turn-off delay time	t _{d(off)}	$R_g = 9$	9.1 Ω, V _{GS} = 10 V	-	57	86	ns
Fall time	t _f			-	29	58	
Gate input resistance	R _g	f = 1 MHz, open drain		-	0.56	-	Ω
Drain-Source Body Diode Characteristic	s	•		•	•	•	
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12	•
Pulsed diode forward current	I _{SM}			-	-	50	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 16.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	338	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S,$ dl/dt = 100 A/µs, V _R = 25 V		-	5.3	-	μC
Reverse recovery current	I _{RRM}			-	29	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



SiHA25N50E

Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

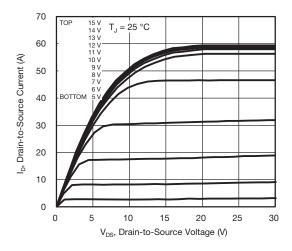
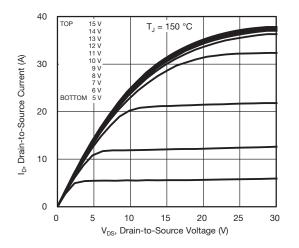


Fig. 1 - Typical Output Characteristics





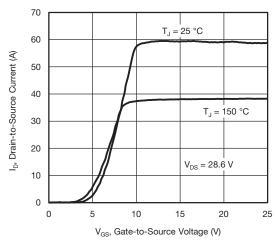


Fig. 3 - Typical Transfer Characteristics

S17-1308-Rev. E, 21-Aug-17

3.0 12 R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 0.5 0 -40 -60 -20 0 20 40 60 80 100 120 140 160 T_., Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

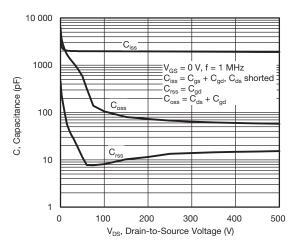


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

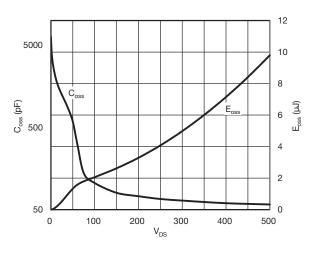


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

3

Document Number: 91628

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



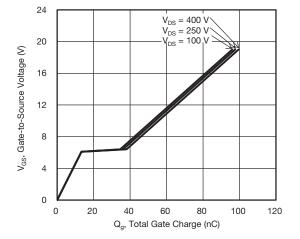


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

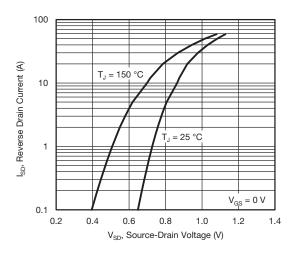


Fig. 8 - Typical Source-Drain Diode Forward Voltage

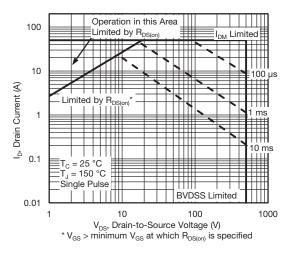


Fig. 9 - Maximum Safe Operating Area

30 24 I_D, Drain Current (A) 18 12 6 0 25 50 100 125 150 75 T_C, Case Temperature (°C)

Fig. 10 - Maximum Drain Current vs. Case Temperature

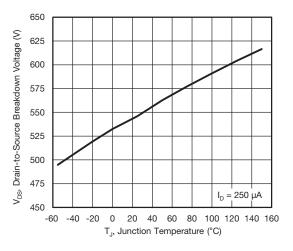


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

Vishay Siliconix

S17-1308-Rev. E, 21-Aug-17

4

For technical questions, contact: hvm@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

SiHA25N50E



SiHA25N50E

Vishay Siliconix

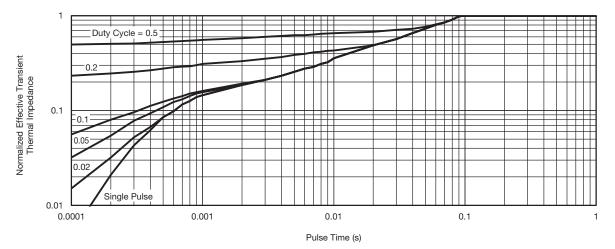


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

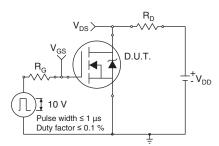


Fig. 13 - Switching Time Test Circuit

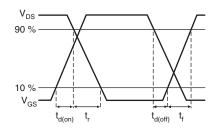


Fig. 14 - Switching Time Waveforms

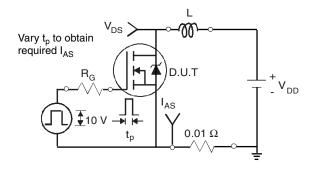


Fig. 15 - Unclamped Inductive Test Circuit

S17-1308-Rev. E, 21-Aug-17

5

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

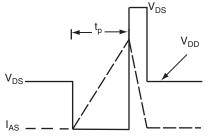


Fig. 16 - Unclamped Inductive Waveforms

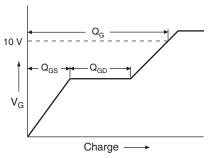
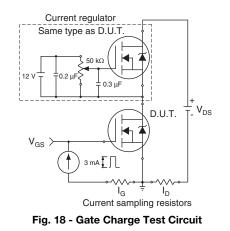
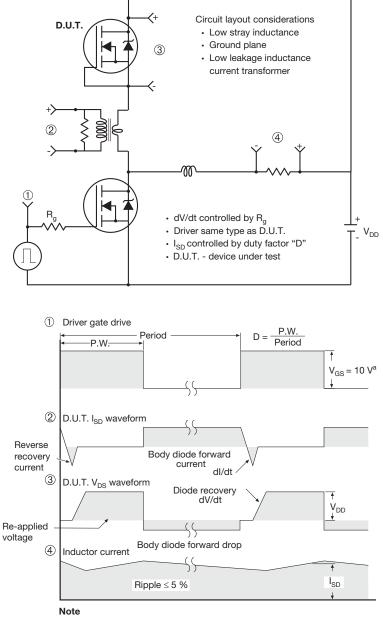


Fig. 17 - Basic Gate Charge Waveform





Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91628.

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix

TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.